

## Product Summary

V <sub>RRM</sub> (V)	I <sub>o</sub> (A)	V <sub>F</sub> Max (V)	I <sub>R</sub> Max (μA)
60	2	0.62	100

## Features and Benefits

- Guard Ring Die Construction for Transient Protection
- High Current Capability
- Low Leakage Current
- Patented Interlocking Clip Design for High Surge Current Capacity
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

## Applications

- Bridge Diodes
- Blocking Diodes
- Reverse Protection Diodes

## Mechanical Data

- Case: PowerDI<sup>®</sup>123
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity Indicator: Cathode Band
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.018 grams (Approximate)

PowerDI123



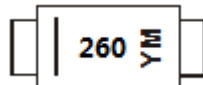
Top View

## Ordering Information (Note 4)

Part Number	Case	Packaging
SDM260P1-7	PowerDI123	3,000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information



260 = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year (ex: E = 2017)  
 M = Month (ex: 5 = May)

### Date Code Key

Year	2014	2015	2016	2017	2018	2019	2020	2021	2022	2023
Code	B	C	D	E	F	G	H	I	J	K

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	60	V
Working Peak Reverse Voltage	V <sub>RWM</sub>		
DC Blocking Voltage	V <sub>R</sub>		
Average Forward Current	I <sub>F(AV)</sub>	2.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	60	A

**Thermal Characteristics**

Characteristic	Symbol	Typ	Unit
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θJA</sub>	60	°C/W
Thermal Resistance, Junction to Case (Note 5)	R <sub>θJC</sub>	5	°C/W
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage	V <sub>F</sub>	—	0.56	0.62	V	I <sub>F</sub> = 2.0A, T <sub>A</sub> = +25°C
		—	0.52	—		I <sub>F</sub> = 2.0A, T <sub>A</sub> = +125°C
Leakage Current (Note 6)	I <sub>R</sub>	—	15	100	μA	V <sub>R</sub> = 60V, T <sub>A</sub> = +25°C
		—	10	—		V <sub>R</sub> = 60V, T <sub>A</sub> = +125°C
Typical Capacitance	C <sub>T</sub>	—	52	—	pF	V <sub>R</sub> = 10V, f = 1.0MHz

Notes: 5. Device mounted on 1inch sq. copper pad, 2oz.  
6. Short duration pulse test used to minimize self-heating effect.

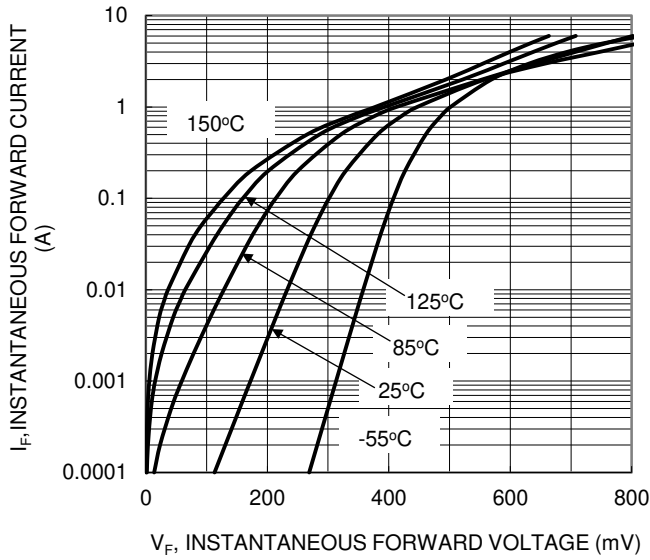


Figure 1. Typical Forward Characteristics

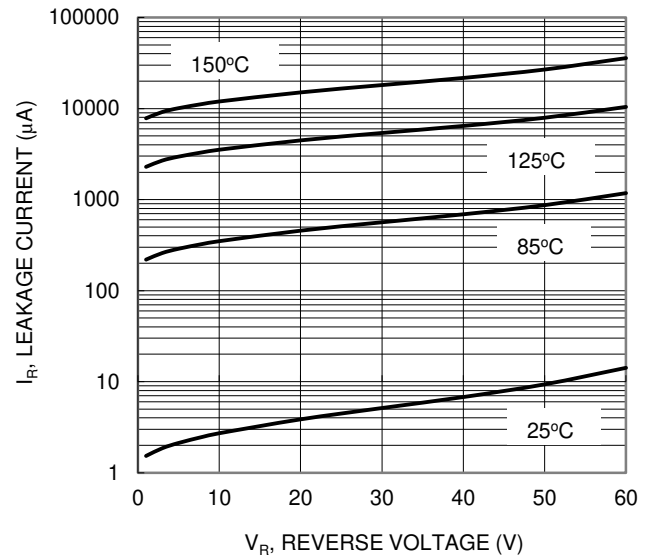


Figure 2. Typical Reverse Characteristics

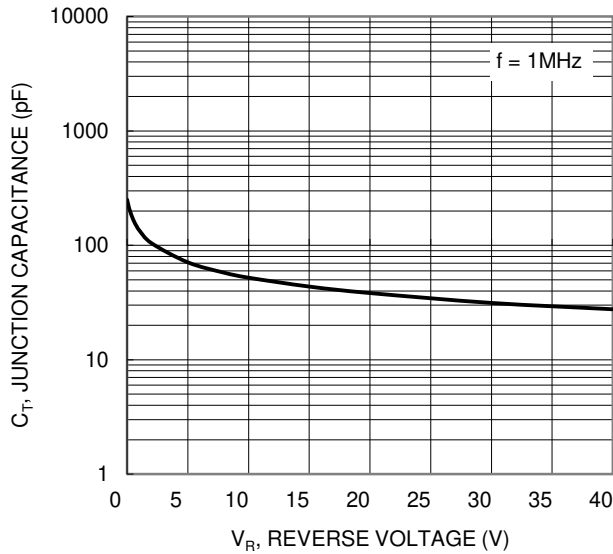


Figure 3. Typical Junction Capacitance

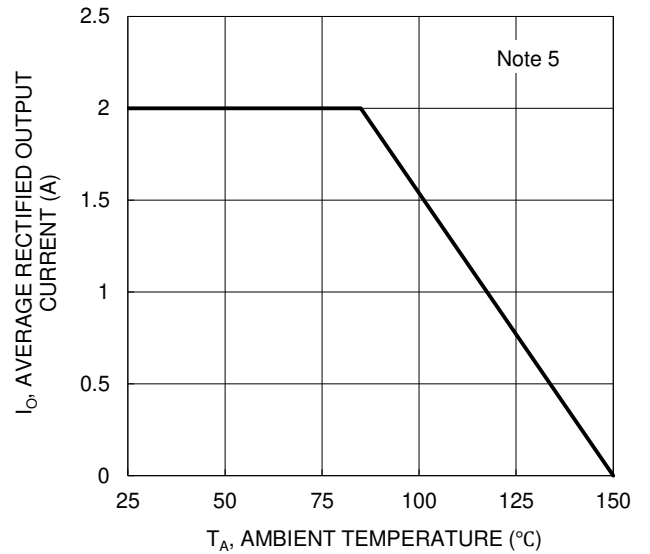
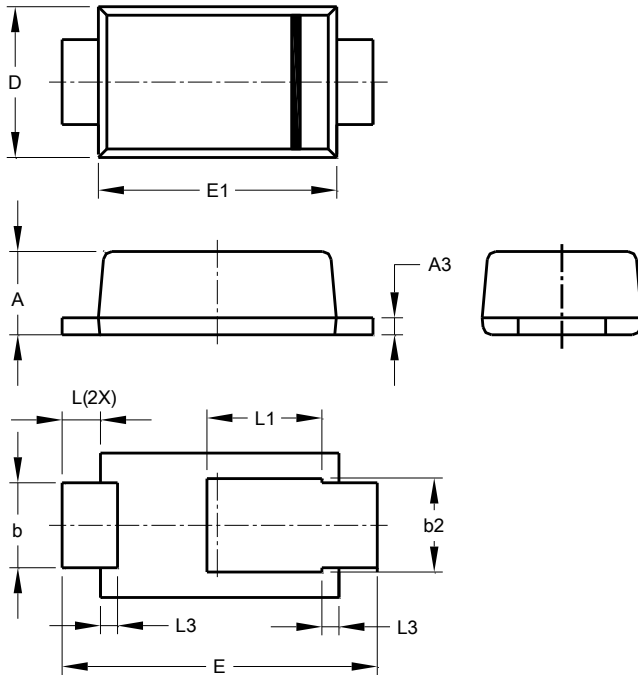


Figure 4. DC Forward Current Derating

## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### PowerDI123

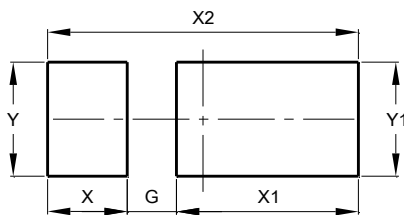


PowerDI123			
Dim	Min	Max	Typ
A	0.93	1.00	0.98
A3	0.15	0.25	0.20
b	0.85	1.25	1.00
b2	1.025	1.125	1.10
D	1.63	1.93	1.78
E	3.50	3.90	3.70
E1	2.60	3.00	2.80
L	0.40	0.50	0.45
L1	1.25	1.40	1.35
L3	0.125	0.275	0.20
All Dimensions in mm			

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### PowerDI123



Dimensions	Value (in mm)
G	0.65
X	1.05
X1	2.40
X2	4.10
Y	1.50
Y1	1.50

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